Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1	IPC Web Site for Information on IPC-1752 Standard				Form Type Distribute									
Supplier	Information													
Company	Company name*			Company unique ID			Unique ID Authority				Response Date*			
onsemi										2024-0	2024-05-04			
Contact N	ame	Title - Contac	Title - Contact			Phone - Contact*				Email - Contact*				
Product-E	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized	d Representative*	Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date	Version	Manufacturing Site	Manufacturing Site		UOM	Unit Type	
	74LCX1		2MTCX 3V DUAL JK FF		7		2024-05-04		PH1	PH1		mg	Each	
Manufacturing Process Information														
	Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-0		L Rating	Peak Process Body Temperatu		erature Max Time at Pea	ak Temper	ature Number	Number of Reflow Cycles		
	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		TU Alloy 1		1		260	C	30	seco	seconds 3			
Comments														
level 1 - maximum time at peak temperature during soldering is 10-30 seconds														
For more information regarding material composition please refer to page 3														

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier needs to supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.74	mg	Supplier	Silicon (Si)	7440-21-3		0.74	mg
Die Attach	0.084	mg	Supplier	Ethylene glycol dicyclopentenyl ether methacrylate	68586-19-6		0.0029	mg
			Supplier	Bis(a,a-dimethylbenzyl) Peroxide	80-43-3		0.0005	mg
			Supplier	Silver (Ag)	7440-22-4		0.0805	mg
Lead Frame	23.228	mg	Supplier	Zinc (Zn)	7440-66-6		0.0279	mg
			Supplier	Iron (Fe)	7439-89-6		0.5459	mg
			Supplier	Copper (Cu)	7440-50-8		22.6473	mg
			Supplier	Phosphorus (P)	7723-14-0		0.007	mg
Mold Compound-Black	31.8	mg		Epoxy resin	proprietary data		3.021	mg
			Supplier	Phenol Resin	Proprietary Data		1.59	mg
			Supplier	Carbon Black (C)	1333-86-4		0.159	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		27.03	mg
Plating	0.178	mg	Supplier	Palladium (Pd)	7440-05-3		0.005	mg
			В	Nickel (Ni)	7440-02-0		0.17	mg
			Supplier	Gold (Au)	7440-57-5		0.003	mg
Wire Bond - Au	0.397	mg	Supplier	Gold (Au)	7440-57-5		0.397	mg